

A1
cancel 11d

6 a trace stub to counteract the attractive force applied by the
7 trace, said trace stub coupled to said pad and extending away from said pad in a
8 direction other than said first direction.

1 Please cancel claim 9.

A2

1 10. (Amended) A bonding system comprising:
2 a bond pad;
3 a trace coupled to said bond pad and extending away from said
4 pad; and
5 an element adapted to counteract an attractive force applied by the
6 trace to solder placed on the bond pad.

A3

1 16. (Amended) The system of claim 10 wherein the attractive force
2 applied by the trace to said solder arises from said trace being coupled to and
3 extending away from said bond pad, said element adapted to emulate said trace.

REMARKS

Section 112 Rejection

Claim 16 was rejected under 35 U.S.C. § 112, second paragraph as being indefinite. Specifically, the Examiner stated that the claim was unclear because it was uncertain whether the recited functions followed from the claimed structure of the stub and the trace or whether they arise from some other structural feature not explicitly stated in the claim.

Claim 16 has been amended to clarify that the function follows from the claimed structure of the trace and the trace stub. Claim 10 calls for an element to counteract an attractive force that is applied by the trace to solder that is placed on a bond pad. Amended claim 16 specifies that it is the attractive force of claim 10 that arises from the trace being coupled to and extending away from